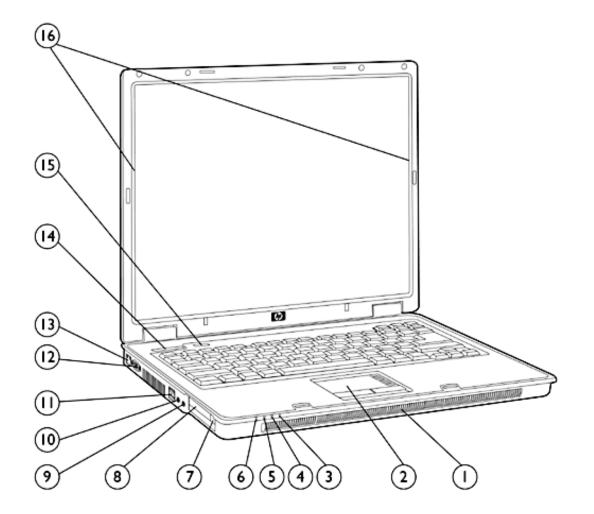
Overview

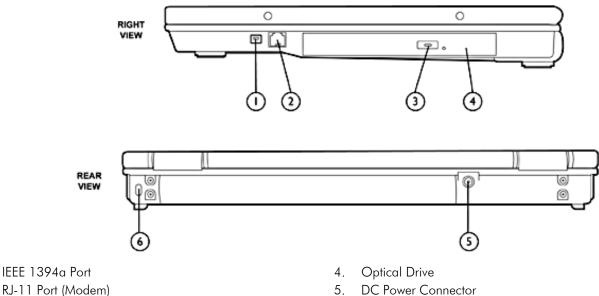


- 1. Stereo Speakers
- 2. Touchpad with Scroll Zone
- 3. Hard Drive Activity LED
- 4. Battery Charging LED
- 5. Power/Standby LED
- 6. Wireless On/Off LED
- 7. PC Card Eject Button
- 8. PC Card Slot

- 9. Microphone Jack
- 10. Headphone Jack
- 11. 2 USB 2.0 Ports
- 12. VGA/External Monitor Connector
- 13. RJ-45 Port (NIC)
- 14. Power Button with LED
- 15. Wireless On/Off Button with LED
- 16. Dual-band Wireless LAN Antennas



Overview



3. **Optical Drive Button**

- DC Power Connector
- 6. Kensington Lock Slot

At A Glance

1.

2.

- Genuine Windows XP Professional, Genuine Windows XP Home Edition, or **FreeDOS**
- Intel® Core™ Duo Processors T2300 to T2600*, Intel Core Solo Processor T1300* .
- Sleek industrial design starting at 5.7 lb/2.59 kg and 1.2-inch/30.3 mm thin at front •
- Mobile Intel 945GM Express Chipset or Mobile Intel 940GML Express Chipsett •
- Supports up to 4GB** of 533- or 667-MHz DDR2 SDRAM, dual channel memory support
- Up to 100-GB 5400 rpm, user-removable hard drive .
- Intel Graphics Media Accelerator 950 •
- Optional integrated 802.11 a/b/g or 802.11 b/g wireless LAN module and Bluetooth® ٠
- Broadcom 10/100 Ethernet PCI Controller •
- Touchpad with scroll zone
- Protected by one-year standard parts and labor warranty certain restrictions and exclusions apply ٠

* Intel's numbering system is not a measurement of higher performance. Intel Core Duo and Core Solo processors available with Intel 945GM Express Chipset only.

† Mobile Intel 940GML Express Chipset available in May 2006.

** 4-GB memory available with Intel 945GM Express Chipset only. Above 3-GB, all memory may not be available due to system resource requirements.



Standard Features

Processors	Intel Core Duo Proc Intel Core Solo Proc Intel Core Solo Proc Intel Celeron M Proc Intel Celeron M Proc * Intel's numbering is processors available	e Duo Processor T2600* (2.16-GHz, 667-MHz FSB, 2-MB L2 cache) e Duo Processor T2500* (2.00-GHz, 667-MHz FSB, 2-MB L2 cache) e Duo Processor T2400* (1.83-GHz, 667-MHz FSB, 2-MB L2 cache) e Duo Processor T2300* (1.66-GHz, 667-MHz FSB, 2-MB L2 cache) e Duo Processor T2300E* (1.66-GHz, 667-MHz FSB, 2-MB L2 cache) e Duo Processor T2250* (1.73-GHz, 533-MHz FSB, 2-MB L2 cache) (select countries only) e Duo Processor T2050* (1.6-GHz, 533-MHz FSB, 2-MB L2 cache) (select countries only) e Duo Processor T1350* (1.86-GHz, 533-MHz FSB, 2-MB L2 cache) (select countries only) e Solo Processor T1350* (1.86-GHz, 567-MHz FSB, 2-MB L2 cache) (select countries only) e Solo Processor T1300* (1.66-GHz, 667-MHz FSB, 2-MB L2 cache) (select countries only) e Solo Processor T1300* (1.66-GHz, 533-MHz FSB, 2-MB L2 cache) eron M Processor 430* (1.73-GHz, 533-MHz FSB, 1-MB L2 cache) eron M Processor 410* (1.46-GHz, 533-MHz FSB, 1-MB L2 cache) eron M Processor 410* (1.46-GHz, 533-MHz FSB, 1-MB L2 cache) eron M Processor 410* (1.46-GHz, 533-MHz FSB, 1-MB L2 cache) eron M Processor 410* (1.46-GHz, 533-MHz FSB, 1-MB L2 cache) eron M Processor 410* (1.46-GHz, 533-MHz FSB, 1-MB L2 cache) eron M Processor 410* (1.46-GHz, 533-MHz FSB, 1-MB L2 cache) eron M Processor 410* (1.46-GHz, 533-MHz FSB, 1-MB L2 cache) eron M Processor 410* (1.46-GHz, 533-MHz FSB, 1-MB L2 cache) eron M Processor 410* (1.46-GHz, 533-MHz FSB, 1-MB L2 cache) eron M Processor 410* (1.46-GHz, 533-MHz FSB, 1-MB L2 cache) eron M Processor 410* (1.46-GHz, 533-MHz FSB, 1-MB L2 cache) eron M Processor 410* (1.46-GHz, 533-MHz FSB, 1-MB L2 cache) eron M Processor 410* (1.46-GHz, 533-MHz FSB, 1-MB L2 cache) eron M Processor 410* (1.46-GHz, 533-MHz FSB, 1-MB L2 cache) eron M Processor 410* (1.46-GHz, 533-MHz FSB, 1-MB L2 cache) eron M Processor 410* (1.46-GHz, 533-MHz FSB, 1-MB L2 cache) eron M Processor 410* (1.46-GHz, 533-MHz FSB, 1-MB L2 cache) eron M Processor 410* (1.46-GHz, 533-MHz FSB, 1-MB L2 cache) eron M Processor 410* (1.46-GHz, 533-MHz FSB, 1-MB L2 cache) eron M Processor 410*	
Operating System	Preinstalled	Genuine Windows XP Professional SP2 Genuine Windows XP Home Edition SP2 FreeDOS	
	Supported Certified	Genuine Windows 2000 (drivers downloadable from <u>http://www.hp.com</u>) Novell Linux Desktop 9	
Chipset	or	1 Express Chipset with 667-MHz front side bus 1L Express Chipset with 533-MHz front side bus (available May 2006)	
Graphics	Intel Graphics Media	a Accelerator 950 with up to 128-MB shared system memory	
Display	Internal	14.1-inch or 15.0-inch XGA (1024 x 768 resolution and 16 M colors) 15.0-inch XGA BrightView (1024 x 768 resolution and 16 M colors) 15.0-inch SXGA+ wide viewing angle (1400 x 1050 resolution and 16 M colors)	
	External	Up to 32-bit per pixel color depth VGA port supports resolutions up to 2048 x 1536 at 75 Hz, and lower resolutions at up to 100 Hz DVI port in optional HP Docking Station (sold separately) supports resolutions up to 1600 x 1200 at both full and reduced blanking, and 1920 x 1200 at reduced blanking NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.	



Standard Features

Sidilidara i ediores			
Memory	Standard	256-MB, 512-MB, 1024-MB or 2048-MB 533-MHz or 667-MHz DDR2 SDRAM; two SODIMM slots supporting dual channel memory	
	Maximum	Supports up to 4096-MB maximum (2048-MB 667-MHz SODIMM in slots and 2; requires Intel 945GM Express Chipset)	
	Dual-channel	Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory slots.	
	NOTE: Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed. Above 3-GB, all memory may not be available due to system resource requirements.		
Communications		100 Ethernet PCI Controller	
	56K V.92 modem* with di		
	* Designed for downloads from 56K modem compliant sources. Maximum achievable download transmission rates currently do not reach 56 KB/s, and will vary with line conditions. Modem availability is subject to country regulatory approval.		
Wireless Devices	Support for a broad range of secure, integrated wireless LAN options featuring support for the latest industry standards. Integrated Bluetooth is also an option (factory configurable only) and can be combined with any of the supported wireless LAN options.		
	All integrated wireless	Wi-Fi certified	
	LAN options	Cisco Compatible Extensions support (Version 3.0)	
		Wired Equivalent Privacy (WEP) support up to 128-bit keys	
		Wi-Fi Protected Access (WPA) and WPA2 support 802.1x authentication support, including EAP-TLS, EAP-TTLS, PEAP-GTC,	
		PEAP-MSCHAPv2, and LEAP	
		Advanced Encryption Standard (AES) support	
		WiFi certified for WPA2, WMM	
		Dual antennas integrated in the display enclosure	
	Intel PRO/Wireless	Intel Centrino mobile technology	
	3945ABG Network	Integrated support for 802.11a, b and g	
	Connection Intel PRO/Wireless	Up to 54-mbps data rate Intel Centrino mobile technology	
	3945BG Network	Intel Centrino mobile technology Integrated support for 802.11 b and g	
	Connection	Up to 54-mbps data rate	
		Integrated support for 802.11a, b and g	
	Adapter	Up to 54-mbps data rate	
	Broadcom 4311BG WiFi Adapter	Integrated support for 802.11 b and g Up to 54-mbps data rate	
	HP Integrated Module with Bluetooth 2.0 Wireless Technology	Bluetooth Specification v2.0 compliant Works with a wide range of Bluetooth devices	



Standard Features			
Keyboard	The 101/102-key compatible keyboard features an industry standard, full-pitch key layout with desktop keyboard features, such as the isolated inverted-T cursor control keys, editing keys, both left and right control and alt keys, and 12 function keys. US and International key layouts are available. Other features include an integrated numeric keypad, hotkeys for instant access to power conservation, brightness, and other features, 19-mm x 19-mm key pitch (center-to-center spacing), 2.5-mm stroke, comfort-dished keycaps, and bright key legends for improved visibility in low light conditions.		
One-Touch Productivity Buttons	Provides one-touch access to control Wireless On/Off, with LED indicator		
Pointing Device	Touchpad with scroll zone, two soft-touch pick buttons		
Expansion Card Slots	One Type I/II PC Card slot	Supports 32-bit CardBus and 16-bit PC Cards	
Storage		 40-, 60-, 80-, 100-GB 5400 rpm SMART SATA are customer removable and will withstand multiple insertion/removal cycles. br the system recovery software. Hard drive is mounted directly to the notebook frame, reducing the transmission of shock to the hard drive and protecting it during normal use from shock and vibration. 	
	Fixed Optical Drives	CD-ROM DVD-ROM DVD/CD-RW Combo DVD+/-RW SuperMulti with Double Layer LightScribe DVD+/-RW with Double Layer	
Interfaces	PC Card Slot	One Type I/II	
	External Monitor	One – VGA	
	IEEE 1394a Port	One	
	External Microphone	One	
	Headphone/Line out	One	
	Power Connector	One	
	RJ-11 (Modem)	One	
	RJ-45 (NIC)	One	
	USB 2.0	Two	
	Extended Life Battery Connector	One	
	LED Status Indicators	Ten	



Standard Features			
Audio	ADI High Definition CODEC Integrated 16-bit Sound Blaster Pro compatible audio Integrated stereo speakers Stereo headphone/line out Stereo microphone in		
Software	Preinstalled Software Microsoft Windows XP	Adobe Acrobat Reader HP Backup and Recovery Manager HP Help and Support Center HP Mobile Print Driver HP ProtectTools Security Manager: BIOS Configuration for HP ProtectTools Credential Manager for HP ProtectTools HP Quick Launch Buttons HP Wireless Assistant Sonic Digital Media Plus: RecordNow! (for optional DVD+/-RW and DVD/CDRW drives) MyDVD (DVD Authoring for optional DVD+/-RW drives) Synaptics Touchpad Driver Symantec Norton Internet Security with complimentary 60-day live update Intervideo WinDVD – DVD Player (for optional DVD+/-RW, DVD/CDRW and DVD drives)	
	Additional software available from the Web	Smart Card Security for HP ProtectTools Device Access Manager for HP ProtectTools	
HP Backup and Recovery Manager	Each unit is shipped with HP Backup and Recovery Manager. HP Backup and Recovery Manager can provide data and system file protection for HP business PCs to enable fast recovery if the system becomes corrupted or if important information is accidentally deleted. HP Backup and Recovery Manager can perform scheduled or manual backups of the entire drive or individual files and folders. Up to 8 GB of the hard drive is reserved for the system recovery software. HP Backup and Recovery Manager can also create software recovery CDs or DVDs (requires optional hardware).		
SMBIOS Version 2.4	System Management BIOS, previously known as DMI BIOS, is used to store system management information.		
HP ProtectTools Security Manager	ProtectTools Security Man	Manager is the security platform for business notebooks and desktops. The HP ager is an extensible client security console that delivers enhanced security on software modules. Modules currently available are:	
	- BIOS Configuratio - Credential Manag	ity for HP ProtectTools on for HP ProtectTools ger for HP ProtectTools unager for HP ProtectTools	



Standard Features	3			
Security	Standard Features	HP ProtectTools Security Manager Configuration Control Hardware Memory Change Alert Ownership Tag Setup Password Power-On Password DriveLock HP Disk Sanitizer Enabled for PC Smart Card options Kensington Lock Slot Support for Computrace / LoJack for	s or Laptops (must be purchased separately)	
	For more information on	HP security solutions refer to <u>http://ww</u>		
Power Supply		External 65-watt Smart AC adapter, 6-foot (1.8-meter) power cord included. Total length including External AC adapter is 12 feet (3.66 meter).		
	ogy recharges your battery up t		stem is off. Fast Charge Technology does	
not apply to 12-cell UI				
Battery	Primary Battery	6-cell (52Wh) high capacity Lithium 6-cell (43Wh) high capacity Lithium		
			ı-lon	
	Primary Battery Optional HP 8-Cell	6-cell (43Wh) high capacity Lithium	n-lon n-lon	
	Primary Battery Optional HP 8-Cell Extended Life Battery Optional HP 12-Cell	6-cell (43Wh) high capacity Lithium 8-cell (52Wh) high capacity Lithium	n-lon n-lon	
Battery	Primary Battery Optional HP 8-Cell Extended Life Battery Optional HP 12-Cell	6-cell (43Wh) high capacity Lithium 8-cell (52Wh) high capacity Lithium 12-cell (95Wh) high capacity Lithiu	n-lon n-lon m-lon	
Battery	Primary Battery Optional HP 8-Cell Extended Life Battery Optional HP 12-Cell Ultra-Capacity Battery Primary Battery Primary Battery and optional HP 8-Cell	6-cell (43Wh) high capacity Lithium 8-cell (52Wh) high capacity Lithium 12-cell (95Wh) high capacity Lithiu 6-cell (52Wh) Primary	n-lon m-lon 6-cell (43Wh) Primary	
Battery	Primary Battery Optional HP 8-Cell Extended Life Battery Optional HP 12-Cell Ultra-Capacity Battery Primary Battery Primary Battery and optional HP 8-Cell Extended Life Battery Primary Battery and optional HP 12-Cell	6-cell (43Wh) high capacity Lithium 8-cell (52Wh) high capacity Lithium 12-cell (95Wh) high capacity Lithiu 6-cell (52Wh) Primary Up to 5 hours	n-lon m-lon 6-cell (43Wh) Primary Up to 4 hours and 30 minutes	
Battery	Primary Battery Optional HP 8-Cell Extended Life Battery Optional HP 12-Cell Ultra-Capacity Battery Primary Battery Primary Battery and optional HP 8-Cell Extended Life Battery Primary Battery and optional HP 12-Cell Ultra-Capacity Battery NOTE: Battery life will va on the product, power mo	6-cell (43Wh) high capacity Lithium 8-cell (52Wh) high capacity Lithium 12-cell (95Wh) high capacity Lithiu 6-cell (52Wh) Primary Up to 5 hours Up to 10 hours and 15 minutes Up to 15 hours	n-lon m-lon 6-cell (43Wh) Primary Up to 4 hours and 30 minutes Up to 9 hours and 45 minutes Up to 13 hours	



Standard Features	
Power Conservation	Supports enhanced Intel SpeedStep technology on models with Mobile Intel 945GM Express Chipset that have Intel Core Duo processors (allows Battery Optimized Mode, Maximum Performance Mode, or Automatic mode)
	Intel Display Power Saving technology
	Hibernation
	Standby
	ACPI compliance
Service and Support	HP Services includes a one-year standard parts and labor warranty, pick-up or carry-in, and toll-free 7 x 24 hardware technical phone support. On-site service and warranty upgrades are also available.
	NOTE: Certain restrictions and exclusions apply. Consult the HP Customer Support Center for details. <u>http://h20000.www2.hp.com/bizsupport/TechSupport/ProductRoot.jsp</u> .



Options		
Memory	256-MB 533-MHz DDR2 SDRAM	PE830A
	512-MB 533-MHz DDR2 SDRAM	PE831A
	1024-MB 533-MHz DDR2 SDRAM	PE832A
	512-MB 667-MHz DDR2 SDRAM	EM993AA
	1024-MB 667-MHz DDR2 SDRAM	EM994AA
	2048-MB 667-MHz DDR2 SDRAM	EM995AA
Other Storage	80-GB 5400 rpm Primary SATA Hard Drive	ET354AA
	HP USB Digital Drive + 128-MB Secure Digital Card	DL702A
	HP USB Digital Drive + 256-MB Secure Digital Card	DL702AA
	HP USB Diskette Drive	DC361B
Communications	Intel PRO/Wireless 3945ABG 802.11 a/b/g WLAN option kit	EX150AA#xxx
Expansion Solutions	HP 4-port USB 2.0 Hub	DG954A
Power	HP 2-bay Battery Charging Station	DT533A#xxx
	HP 10-bay Battery Charging Station	DT534A#ABA
	Battery Adapter kit #1	PK402A
	65W Smart AC Adapter	ED494AA#xxx
	90W Smart AC Adapter	ED495AA#xxx
	90W Smart Auto Adapter	ED493AA
	65W Air/Auto/AC Combo Adapter	ED993AA#xxx
	90W Aircraft Cables	DC899A
	Primary 6-cell Battery Pack	PB994A
	HP 8-cell Extended Life Battery	PB993A
	HP 12-cell Ultra-Capacity Battery	EJ092AA
Carrying Cases	HP Entry Value Case	DL617A
	HP Top Load Nylon	DC915A
	HP Executive Leather case	PA847A
	HP Sport Backpack	DG102A
Security	HP PCMCIA Smart Card Reader	DC350B
	HP/Kensington Cable Lock	PC766A
Input/Output Devices	USB/PS2 Keyboard	DC852A#xxx
	USB/PS2 Optical Mouse	DC369A
	HP USB Optical Travel Mouse	F2100A



Memory

Support for up to 4096 MB* of 533- or 667-MHz DDR2 SDRAM Two DIMM slots DIMM sizes supported: 256 MB, 512 MB, 1024 MB, and 2048 MB

Standard Memory	 256 MB (256 MB x 1)
-	• 512 MB (512 MB x 1 or 256 MB x 2)
	• 1024 MB (1024 MB x 1 or 512 MB x 2)
	 2048 MB (1024 MB x 2)

Optional Memory Upgrades

Support for up to 4096 MB* of memory is available (with the installation of optional DDR2 SDRAM memory kits). Both memory slots are user accessible. Please refer to the Hardware and Software Guide for installation procedures. Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory slots.

Up to	Slot 1	Slot 2
768 MB	512 MB	256 MB
1024 MB	1024 MB	Empty
1024 MB	512 MB	512 MB
1280 MB	1024 MB	256 MB
1536 MB	1024 MB	512 MB
2048 MB	1024 MB	1024 MB
4096 MB*	2048 MB	2048 MB

NOTE: This chart does not represent all possible memory configurations. Due to the non-industry standard nature of some third-party memory modules, we strongly recommend using only HP branded memory modules to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

Memory Upgrades	256-MB 533-MHz DDR2 SDRAM 512-MB 533-MHz DDR2 SDRAM 1024-MB 533-MHz DDR2 SDRAM 512-MB 667-MHz DDR2 SDRAM 1024-MB 667-MHz DDR2 SDRAM 2048-MB 667-MHz DDR2 SDRAM	PE830A PE831A PE832A EM993AA EM994AA EM995AA
		2, , e, e, e,

* 4-GB memory available with Intel 945GM Express Chipset only. Above 3-GB, all memory may not be available due to system resource requirements.



Storage

Removable Media Drive Support

	Quantity Supported	Drive Bay
LightScribe DVD+/-RW Drive with Double Layer	One	Fixed optical drive bay
DVD+/-RW SuperMulti Drive with Double Layer	One	Fixed optical drive bay
DVD/CD-RW Combo Drive	One	Fixed optical drive bay
DVD-ROM Drive	One	Fixed optical drive bay
CD-ROM Drive	One	Fixed optical drive bay

Hard Drive Support

	Quantity Supported	Drive Bay
Primary Hard Drives		
100-GB 5400 rpm SMART SATA Hard Drive	One	Dedicated hard drive bay
80-GB 5400 rpm SMART SATA Hard Drive	One	Dedicated hard drive bay
60-GB 5400 rpm SMART SATA Hard Drive	One	Dedicated hard drive bay
40-GB 5400 rpm SMART SATA Hard Drive	One	Dedicated hard drive bay



Technical Specifications

System Unit	Dimensions (HxWxD)		5 in (30.3 (at front) x 328.6 x 266.7 mm)		
	Weight	with 14.1-inch display	5.7 lb (2.59 kg)		
		with 15.0-inch display	6.1 lb (2.77 kg)		
	NOTE: Height varies depending upon where on the notebook the measurement is made. Weight varies by configuration and components. Weight includes 6-cell battery, 60-GB hard drive, 256-MB memory, and CD-ROM drive. Weight varies by configuration and components.				
	Stand-Alone Power Requirements	Normal Operating Voltage	18.5 V		
		Average Operating Power	12.5 W		
		Max Operating Power	< 65 W		
	Temperature	Operating	32° to 95° F (0° to 35° C) (not writing optical)		
			41° to 95° F (5° to 35° C) (writing optical)		
		Non-operating	-4° to 140° F (-20° to 60° C)		
	Relative Humidity	Operating	10% to 90%, non-condensing		
		Non-operating	5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature		
	Shock	Operating	125 G, 2 ms, half-sine		
		Non-operating	200 G, 2 ms, half-sine		
	Random Vibration	Operating	0.75 grms		
		Non-operating	1.50 grms		
	Altitude	Operating	-50 to 10,000 ft (-15.24 to 3,048 m)		
	(unpressurized)	Non-operating	-50 to 40,000 ft (-15.24 to 12,192 m)		
	Industry Standard	UL	Yes		
	Certifications	CSA	Yes		
		FCC Compliance	Yes		
		Energy Star Compliant	Yes		
		ICES	Yes		
		GS	Yes		
		Australia / NZ A-Tick Compliance	Yes		
		CCC	Yes		
		Japan VCCI Compliance	Yes		
		MIC	Yes		
		BSMI	Yes		
		CE Marking Compliance	Yes		
		BNCI or BELUS	Yes		
		CIT	Yes		
		GOST	Yes		
		Saudi Arabian Compliance (ICCP)	Yes		
		SABS	Yes		
		UKRSERTCOMPUTER	Yes		



Technical Specificat	tions		
HP 65W Smart AC Adapter	Dimensions Weight Input	4.17 x 1.85 x 1.1 in (10.0 0.62 lb (280 g) 100 to 240 VAC	
		Input Efficiency Input frequency range	83% min at 115 VAC 47 to 63 Hz
		Input AC current	1.7 A at 90 VAC, 0.85 A at 180 VAC
	Output	Output power 65W	65W
	•	DC output	18.5V
		Hold-up time	5 msec at 115 VAC input
		Output current limit	<11A, Over voltage protection- 29V max automatic shutdown
	Connector	3 pin/grounded, mates w	ith interchangeable cords
	Environmental Design	Operating temperature	32° to 104° F (0° to 40° C)
		Non-operating (storage) temperature	-4° to 149° F (-20° to 65° C)
		Altitude	0 to 10,000 ft (0 to 3,048 m)
		Humidity	20% to 80%
		Storage Humidity	10% to 90%
	EMI and Safety Certifications	standards – IEC60950, E approvals – C-UL-US, NC	e with LVD and EMC directives; Worldwide safety N60950, UL60950, Class1, SELV; Agency DRDICS, DENAN, EN55022 Class B, FCC Class B, NOM-1 NYCE; MTBF – over 200,000 hours at
	Option Kit Contents	65W AC Adapter, power	cable, warranty booklet
Optional HP 12-Cell	Dimensions (H $x $ W $x $ L)	1.3 x 6.0 x 10.6 in (3.33	x 15.25 x 26.88 cm)
Ultra-Capacity Battery	Weight	1.77 lb (0.803 kg)	
	Cells/Type	12-cell Lithium-Ion	
	Energy	Voltage	14.8V
		Watt-hour Capacity	95Wh
		Amp-hour Capacity	6.45Ah
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)
		Operating (Discharging)	14° to 140° F (–10° to 60° C)
		Non-operating	-4° to 140° F (-20° to 60° C)
	Battery Re-Charge Time	Smart Adapter	3 to 4 hours
		System ON	4 to 5 hours (depending on system power consumption)
	Fuel Gauge	When pressed, LEDs light	indicating level of charge remaining on battery



Technical Specificat	tions			
Optional HP 8-Cell Extended Life Battery	Dimensions (H \times W \times L) Weight	1.0 x 3.9 x 8.7 in (2.5 x 10.0 x 22.0 cm) 1.00 lb (0.455 kg)		
	Cells/Type -	8-cell Lithium-Ion		
	Energy	Voltage	14.4V	
		Watt-hour Capacity	52Wh	
	- .	Amp-hour Capacity	3.6Ah	
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)	
		Operating (Discharging)	14° to 140° F (–10° to 60° C)	
		Non-operating	-4° to 140° F (-20° to 60° C)	
	Battery Re-Charge Time	System in OFF mode or Standby	3 hours	
		System ON	3 to 5 hours (depending on system power consumption)	
		HP Fast Charge Technology	Charges the battery up to 90% within 90 minutes when system is OFF	
	Fuel Gauge	When pressed, LEDs light indicating level of charge remaining on battery		
52Wh Primary 6-Cell	Dimensions (H $x $ W $x $ L)	0.8 x 2.1 x 8.0 in (2.0 x 5.3 x 20.3 cm)		
Battery	Weight	0.737 lb (0.335 kg)		
	Cells/Type	6-cell Lithium-Ion		
	Energy	Voltage	10.8V	
	57	Watt-hour Capacity	52Wh	
		Amp-hour Capacity	4.8Ah	
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)	
	·	Operating (Discharging)	14° to 140° F (–10° to 60° C)	
		Non-operating	–4° to 140° F (–20° to 60° C)	
	Battery Re-Charge Time	System in OFF Mode or Standby	2.5 hours	
		System ON	3 to 5 hours (depending on system power consumption)	
		HP Fast Charge Technology	Charges the battery up to 90% within 1.5 hours when system is OFF	



Technical Specificat	ions			
43Wh Primary 6-Cell Battery	Dimensions (H x W x L) Weight Cells/Type	0.8 x 2.1 x 8.0 in (2.0 x 5.3 x 20.3 cm) 0.715 lb (0.325 kg) 6-cell Lithium-Ion		
	Energy	Voltage Watt-hour capacity Amp-hour capacity	10.8V 43Wh 4.0Ah	
	Temperature	Operating (Charging) Operating (Discharging) Non-operating	32° to 113° F (0° to 45° C) 14° to 140° F (–10° to 60° C) –4° to 140° F (–20° to 60° C)	
	Battery Re-Charge Time	System in OFF mode or Standby	2.5 hours	
		System ON	3 to 5 hours (depending on system power consumption)	
		HP Fast Charge Technology	Charges the battery up to 90% within 1.5 hours when system is OFF	
15.0-Inch Color TFT	Active Area (₩ x H)	12.0 x 9.0 in (30.4 x 22.8 cm)		
SXGA+ Wide Viewing	Diagonal Size	15.0 in (38.0 cm)		
Angle Display	Surface Treatment	Anti-glare		
	Number of Colors	Up to 16M		
	Contrast Ratio	300:1 (typical)		
	Refresh Rate	60 Hz		
	Brightness	170 nit (typical)		
	Pixel Resolution	Pitch	0.217 mm	
		Format	1400 x 1050	
		Configuration	RGB Stripe	
	Backlight	CCFL		
	PPI	117		
	Viewing Angle	$\pm 60^{\circ}$ Horizontal, $+40^{\circ}/-$	45° Vertical (typical)	



Technical Specificati	ons			
15.0-Inch Color TFT	Active Area (W x H)	12.0 x 9.0 in (30.4 x	22.8 cm)	
XGA Display	Diagonal Size	15.0 in (38.0 cm)		
	Surface Treatment	Anti-glare		
	Number of Colors	Up to 16M		
	Contrast Ratio	300:1 (typical)		
	Refresh Rate	60 Hz		
	Brightness	150 nit (typical)		
	Pixel Resolution	Pitch	0.296 mm	
		Format	1024 x 768	
		Configuration	RGB Stripe	
	Backlight	CCFL		
	PPI	86		
	Viewing Angle	$\pm 45^{\circ}$ Horizontal, ± 2	5° Vertical (typical)	
15.0-Inch Color TFT	Active Area ($W \times H$)	12.0 x 9.0 in (30.4 x	22.8 cm)	
XGA BrightView Display	Diagonal Size	15.0 in (38.0 cm)		
	Surface Treatment	BrightView		
	Number of Colors	Up to 16M		
	Contrast Ratio	300:1 (typical)		
	Refresh Rate	60 Hz		
	Brightness	150 nit (typical)		
	Pixel Resolution	Pitch	0.296 mm	
		Format	1024 x 768	
		Configuration	RGB Stripe	
	Backlight	CCFL		
	PPI	86		
	Viewing Angle	$\pm45^{\circ}$ Horizontal, ±2	5° Vertical (typical)	
14.1-Inch Color TFT	Active Area (W × H)	11.2 x 8.4 in (28.6 x	21.4 cm)	
XGA Display	Diagonal Size	14.1 in (35.7 cm)	,	
	Surface Treatment	Anti-glare		
	Number of Colors	Up to 16M		
	Contrast Ratio	300:1 (typical)		
	Refresh Rate	60 Hz		
	Brightness	170 nit (typical)		
	Pixel Resolution	Pitch	0.279 mm	
		Format	1024 x 768	
		Configuration	RGB Stripe	
	Backlight	CCFL		
	PPI	91		
	Viewing Angle	$\pm45^{\circ}$ Horizontal, ±2	5° Vertical (typical)	



Hard Drives

100-GB 5400 rpm SATA	Drive Weight	0.22 lb (101 g)	
100-06 J400 Ipili JAIA	0	100 GB	
	Capacity Haist		
	Height	0.37 in (9.5 mm)	
	Width	2.75 in (70 mm)	
	Interface	ATA-7 / SATA 1.0a	
	Transfer Rate	Synchronous (maximum)	100 MB/s (Drive Capability)
	Seek Time	Single Track	3 ms
	(typical reads, including settling)	Average	13 ms
	senning	Maximum	24 ms
	Rotational Speed	5400 rpm	
	Logical Blocks	195,371,568	
	Operating Temperature	41° to 140° F (5° to 60° C	C) [case temp]
	Features	ATA Security	
80-GB 5400 rpm SATA	Drive Weight	0.22 lb (101 g)	
	Capacity	80 GB	
	Height	0.37 in (9.5 mm)	
	Width	2.75 in (70 mm)	
	Interface	ATA-7 / SATA 1.0a	
	Transfer Rate	Synchronous (maximum)	100 MB/s (Drive Capability)
	Seek Time	Single Track	3 ms
	(typical reads, including	Average	13 ms
	settling)	Maximum	24 ms
	Rotational Speed	5400 rpm	
	Logical Blocks	156,301,488	
	Operating Temperature	41° to 140° F (5° to 60° C	C) [case temp]
	Features	ATA Security	



Technical Specifications

60-GB 5400 rpm SATA	Drive Weight	0.22 lb (101 g)	
· ·	Capacity	60 GB	
	Height	0.37 in (9.5 mm)	
	Width	2.75 in (70 mm)	
	Interface	ATA-7 / SATA 1.0a	
	Transfer Rate	Synchronous (maximum)	100 MB/s (Drive Capability)
	Seek Time	Single Track	3 ms
	(typical reads, including	Average	13 ms
	settling)	Maximum	24 ms
	Rotational Speed	5400 rpm	
	Logical Blocks	117,231,408	
	Operating Temperature	41° to 140° F (5° to 60° C	C) [case temp]
	Features	ATA Security	
40-GB 5400 rpm SATA	Drive Weight	0.22 lb (101 g)	
	Capacity	40 GB	
	Height	0.37 in (9.5 mm)	
	Width	2.75 in (70 mm)	
	Interface	ATA-7 / SATA 1.0a	
	Transfer Rate	Synchronous (maximum)	100 MB/s (Drive Capability)
	Seek Time	Single Track	3 ms
	(typical reads, including	Average	13 ms
	settling)	Maximum	24 ms
	Rotational Speed	5400 rpm	
	Logical Blocks	78,165,360	
	Operating Temperature	41° to 140° F (5° to 60° C	C) [case temp]

Removable Storage Drives – Fixed Bay

CD-ROM Drive	Access Times	Random	<110 ms CD
	Max Data Transfer Rate	24X CD-ROM	3,600 KB/s
	Transfer Mode	Multiword DMA Mod	de 2
	Interface	EIDE	
	Supported Media (read)	MODE CD, CD-I, C	CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED D-I Bridge (Photo-CD, Video CD), Multisession CD RA, Portfolio, CD-R, CD-RW), CD-R, CD-RW
	Supported Media (write)	None	
	Max Media Capacity (read)	700 MB	
	Transport	Tray Loading	



Technical Specifications

rechnical specifical	10113		
DVD-ROM Drive	Access Times	Random	<116 ms CD
			<125 ms DVD
	Max Data Transfer Rate	24X CD-ROM	3,600 KB/s
		8X-DVD	10,800 KB/s
	Transfer Mode	Multiword DMA Mode 2	
	Interface	EIDE	
	Supported Media (read)	MODE CD, CD-I, CD-I B (Photo-CD, CD-EXTRA, P	MDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED Bridge (Photo-CD, Video CD), Multisession CD ortfolio, CD-R, CD-RW), CD-R, CD-RW, DVD- VD-10, DVD-18), DVD-R, DVD-RW, DVD+R,
	Supported Media (write)	None	
	Max Media Capacity (read)	4.7 GB	
	Transport	Tray Loading	
DVD/CD-RW Combo	Access Times	Random	<110 ms CD
Drive			<130 ms DVD
	Max Data Transfer Rate	24X CD-ROM	3,600 KB/s
		8X DVD	10,800 KB/s
		24X CD-R	3,600 KB/s
		24X CD-RW	3,600 KB/s
	Transfer Mode	Multiword DMA Mode 2	
	Interface	EIDE	
	Supported Media (read)	CD-DA, CD+(E)G, CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge (Photo-CD, Video CD), Multisession CD (Photo-CD, CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW, DVD- ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R, DVD-RW, DVD+R, DVD+RW	
	Supported Media (write)	CD-R, CD-RW	
	Max Media Capacity	8.5 GB	
	(read)		
	(redu) Max Media Capacity (write)	700 MB	



Technical Specificati	ons			
LightScribe DVD+/-RW	Access Times	Random	<175 ms CD	
Drive with Double Layer			<230 ms DVD	
	Max Data Transfer Rate	24X CD-ROM	3,600 KB/s	
		8X DVD	10,800 KB/s	
		24X CD-R	3,600 KB/s	
		10X CD-RW	1,500 KB/s	
		8X DVD+R	10,800 KB/s	
		4X DVD + RW	5,400 KB/s	
		8X DVD-R	10,800 KB/s	
		4X DVD-RW	5,400 KB/s	
		2.4X DVD+R(9)	2,700 KB/s	
	Transfer Mode	Multiword DMA Mode	e 2	
	Interface	EIDE		
	Supported Media (read)	MODE CD, CD-I, CD (Photo-CD, CD-EXTRA	CD-DA, CD+(E)G, CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge (Photo-CD, Video CD), Multisession CD (Photo-CD, CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW, DVD- ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R, DVD-RW, DVD+R,	
	Supported Media (write)	CD-R, CD-RW, DVD+	-R, DVD+RW, DVD-R, DVD-RW, LightScribe	
	Max Media Capacity (read)	8.5 GB		
	Max Media Capacity (write)	8.5 GB		
	Transport	Tray Loading		
DVD+/-RW SuperMulti Drive with Double Layer	Access Times	Random	<175 ms CD <230 ms DVD	
	Max Data Transfer Rate	24X CD-ROM	3,600 KB/s	
		8X DVD	10,800 KB/s	
		24X CD-R	3,600 KB/s	
		10X CD-RW	1,500 KB/s	
		8X DVD+R	10,800 KB/s	
		4X DVD+RW	5,400 KB/s	
		8X DVD-R	10,800 KB/s	
		4X DVD-RW	5,400 KB/s	
		2.4X DVD+R(9)	2,700 KB/s	
		5X DVD-RAM	6,750 KB/s	
	Transfer Mode	Multiword DMA Mode	9	
	Interface	EIDE		
	Supported Media (read)	CD-DA, CD+(E)G, CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge (Photo-CD, Video CD), Multisession CD (Photo-CD, CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW, DVD- ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R, DVD-RW, DVD+R, DVD+RW. DVD-RAM		
	Supported Media (write)		- -R, DVD+RW, DVD-R, DVD-RW, DVD-RAM	



Technical Specificat	tions	
	Max Media Capacity (read)	8.5 GB
	Max Media Capacity (write)	8.5 GB
	Transport	Tray Loading
Audio		
Hardware	Implementation	ADI1981HD High Definition CODEC
	Full Duplex	Yes
	Sound Blaster Pro compatible	Yes
	Microphone Jack	Stereo or mono
	Headphone/Line Out Jack	Stereo
Audio Output Quality	Frequency Response	20 Hz – 20 kHz
	Signal to Noise Ratio	>85 dB
	Total Harmonic Distortion	0.01%
	Noise Floor	-110 dB
	Play/Record Sampling Rate(s)	8 kHz– 48 kHz
	DAC	16, 20 or 24-bit
	ADC	16 or 20-bit
Internal Speaker	Power Rating	2 Watts
	Impedance	4 Ohms





Technical Specificati	ions	
Integrated Broadcom 10/100 Ethernet PCI Controller (BCM4401)	Ethernet Features	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30)
		, Auto-Negotiation (Automatic Speed Selection)
		Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s
		IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)
	Power Management	ACPI compliant multiple power modes Situation-sensitive features reduce power consumption
	Manageability	Wake-on-LAN from standby and hibernation (configurable; Magic Packet and Microsoft Wake-Up Frame)
		PXE 2.1 Remote Boot
		Statistics Gathering (RMON, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30))
		Comprehensive diagnostic and configuration software suite
	Interface	32-bit PCI, 33-MHz
	NIC Device Driver Name	Broadcom 440X 10/100 Integrated Controller
	Drivers Available	Microsoft Windows XP Microsoft Windows 2000
V.92 56K Data/Fax	Form Factor	MDC 1.5 Daughtercard
Modem	Power Management Support	APM Revision 1.2, ACPI
	Approvals/ Certifications	UL, CSA, NEMKO, CCIB, Industry Canada, FCC Part 68, CTR21, FCC Part 15 Class B, Canadian ICES-003 Class B, C.I.S.P.R.22, Australian ACA, CE Mark, Other Countries
	Data Mode Capabilities	V.92 data
		V.8bis
		V.80
		V44, V.42bis, MNP5 (Compression)
		V.42 (LAPM, MNP2-4) (Error Correction)
		Optional symbol rates: 2800, 3429 Asymmetric Symbol rates
		Asymmetric Symbol rules
		Synchronous primary channel data signaling rates: 3600, 31200
		3600, 31200 Automatic rate re-negotiation
		3600, 31200 Automatic rate re-negotiation V.34
		3600, 31200 Automatic rate re-negotiation
		3600, 31200 Automatic rate re-negotiation V.34 V.32bis V.32 V.23
		3600, 31200 Automatic rate re-negotiation V.34 V.32bis V.32 V.23 V.23 V.22bis
		3600, 31200 Automatic rate re-negotiation V.34 V.32bis V.32 V.23
		3600, 31200 Automatic rate re-negotiation V.34 V.32bis V.32 V.23 V.22bis V.22bis V.22



Technical Specifica	tions	
	Fax Mode Capabilities	TIA/EIA-578-B (Class 1) T.30, T.4 (Group 3) V.17 V.29 V.27ter V.21 Channel 2
	Command Set	V.250 (Partial) TIA-602 Identification: +GMI, +GMM, +GMR Port control: +IPR, +ICF, +IFC, +ILRR Modulation: +MS, +MR, +MA Error control: +ES, +ER, +EB, +ESR, +ETBM Data compression: +DS, +DR V.251
Broadcom 4311AG 802.11a/b/g WiFi Adapter	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g
	Interoperability	Wi-Fi certified Cisco Compatible Extensions Program compliant (details at <u>www.hp.com/go/notebooks/WLAN</u>)
	Frequency Band	2.4 GHz and 5 GHz
	Data Rates	802.11b: 1, 2, 5.5, 11 Mbps 802.11a/g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	Modulation	Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM
	Security ¹	Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES, 802.1x authentication types EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPv2, LEAP, EAP-FAST, EAP-SIM.
		Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program Version 4).
	Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.
	Media Access Protocol	CSMA/CA (Collision Avoidance) with ACK
	Network Architecture	Ad-hoc (Peer to Peer)
	Models Roaming	Infrastructure (Access Point Required) IEEE 802.11 compliant roaming between access points
	Output Power (for CKK) ²	17.5 dBm
	Output Power (for OFDN power varies by data rate) ²	
	Power Consumption	Transmit: 2.0 W (max) Receive: 1.5 W (max) Idle mode ³ : 390 mW (nominal) Sleep mode: 20 mW (max)
	Power Management	ACPI compliant power management 802.11 compliant power saving mode



Technical Specifications

Receiver Sensitivity ⁴	54 Mbps: -72 dBm, 11	Mbps: -88 dBm , 1 Mbps: -97 dBm	
Antenna type	High efficiency dual band antenna with spatial diversity, mounted in the display enclosure		
Range	802.11 a – Typical (@6 Mbps)	600 feet – Outdoor Open Area 150 feet – Indoor, Office environment	
	802.11 b – Typical (@1 Mbps)	1200 feet – Outdoor Open Area 300 feet – Indoor, Office environment	
	802.11 g – Typical (@1 Mbps)	1200 feet – Outdoor Open Area 300 feet – Indoor, Office environment	
Form Factor	PCI-Express MiniCard		
Weight	0.026 lb (12 g)		
Dimensions	0.19 x 1.2 x 2.0 in (4.7	5 x 29.85 x 50.8 mm)	
Operating Voltage	3.3v +/- 10%		
Temperature	Operating Non-operating	32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C)	
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)	
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)	
Configuration Utility ⁵	Choice of Configuration Utility:		
		rs XP Wireless Network Connection Manager ss Configuration Utility (required for Cisco sions support)	
LED Activity	LED Off – Radio OFF; S	olid LED On – Radio ON	
	wer may vary by country o	es on supported security features. according to local regulations.	
	measured at a packet er 10% for 802.11a/g (OFE	ror rate of 8% for 802.11b (CKK modulation) and a DM modulation).	
5. WLAN supplier's clie		sco Compatible Extensions support. WLAN may also	

Broadcom 4311BG 802.11b/g WiFi Adapter	Wireless LAN Standards	IEEE 802.11b IEEE 802.11g
	Interoperability	Wi-Fi certified Cisco Compatible Extensions Program compliant (details at <u>www.hp.com/go/notebooks/WLAN</u>)
	Frequency Band	2.4 GHz
	Data Rates	802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	Modulation	Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM



Technical Specifications		
Security ¹		WEP, WPA, WPA2, hardware-accelerated AES, es EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP- ST, EAP-SIM.
		Features (proven compatibility with Cisco Aironet bugh the Cisco Compatible Extensions Program
Sub-channels	Multinational support with regulations.	frequency bands and channels compliant to local
Media Access Protocol	CSMA/CA (Collision Avoid	dance) with ACK
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point	
Roaming		aming between access points
Output Power (for CKK) ²	17.5 dBm	
Output Power (for OFDM; power varies by data rate) ²	; 15 dBm	
Power Consumption	Transmit: 2.0 W (max) Receive: 1.5 W (max) Idle mode ³ : 390 mW (nor Sleep mode: 20 mW (max	
Power Management	ACPI compliant power ma 802.11 compliant power s	-
Receiver Sensitivity ⁴	54 Mbps: -72 dBm, 11 M	bps: -88 dBm , 1 Mbps: -97 dBm
Antenna type	High efficiency dual band display enclosure	antenna with spatial diversity, mounted in the
Range	802.11 b – Typical (@1 Mbps)	1200 feet – Outdoor Open Area 300 feet – Indoor, Office environment
	802.11 g – Typical (@1 Mbps)	1200 feet – Outdoor Open Area 300 feet – Indoor, Office environment
Form Factor	PCI-Express MiniCard	
Weight	0.026 lb (12 g)	
Dimensions	0.19 x 1.2 x 2.0 in (4.75 >	< 29.85 x 50.8 mm)
Operating Voltage	3.3v +/- 10%	
Temperature	Operating Non-operating	32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C)
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)



Technical Specification	ons	
	Configuration Utility ⁵	Choice of Configuration Utility:
		 Microsoft Windows XP Wireless Network Connection Manager Broadcom Wireless Configuration Utility (required for Cisco Compatible Extensions support)
	LED Activity	LED Off – Radio OFF; Solid LED On – Radio ON
	 Maximum output po In Power Save Polling Receiver sensitivity is packet error rate of WLAN supplier's clie 	e/driver release for updates on supported security features. wer may vary by country according to local regulations. g mode. measured at a packet error rate of 8% for 802.11b (CKK modulation) and a 10% for 802.11a/g (OFDM modulation). nt utility is required for Cisco Compatible Extensions support. WLAN may also certain third-party software supplicants.
Intel PRO/Wireless 3945ABG 802.11a/b/g Network Connection	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g
	Interoperability	Wi-Fi certified Cisco Compatible Extensions Program compliant (details at <u>www.hp.com/go/notebooks/WLAN</u>)
	Frequency Band	2.4 GHz and 5 GHz
	Data Rates	802.11b: 1, 2, 5.5, 11 Mbps 802.11a/g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	Modulation	Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM
	Security ¹	Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES, 802.1x authentication types EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPv2, LEAP, EAP-FAST, EAP-SIM.
		Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program Version 4).
	Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.
	Media Access Protocol	CSMA/CA (Collision Avoidance) with ACK
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between access points
	Output Power (for CKK) ²	15 dBm
	Output Power (for OFDM; power varies by data rate) ²	15 dBm
	Power Consumption	Transmit: 1.8 Watts (max) Receive: 1.4 Watts (max) Idle mode ³ : 150 mW (nominal) Sleep mode: 30 mW (max)
	Power Management	ACPI compliant power management 802.11 compliant power saving mode
	Receiver Sensitivity ⁴	54 Mbps: -72 dBm, 11 Mbps: -88 dBm , 1 Mbps: -97 dBm



Technical Specifications

	Antenna type	High efficiency dual ba display enclosure	nd antenna with spatial diversity, mounted in the	
	Range	802.11 a – Typical (@6 Mbps)	600 feet – Outdoor Open Area 150 feet – Indoor, Office environment	
		802.11 b – Typical (@1 Mbps)	1200 feet – Outdoor Open Area 300 feet – Indoor, Office environment	
		802.11 g – Typical (@1 Mbps)	1200 feet – Outdoor Open Area 300 feet – Indoor, Office environment	
	Form Factor	PCI-Express MiniCard		
	Weight	0.013 lb (6 g)		
	Dimensions	0.19 x 1.2 x 2.0 in (4.7	75 x 29.85 x 50.8 mm)	
	Operating Voltage	3.3v +/- 10%		
	Temperature	Operating Non-operating	32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C)	
	Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)	
	Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)	
	Configuration Utility ⁵	Choice of Configuration	n Utility:	
			ws XP Wireless Network Connection Manager uired for Cisco Compatible Extensions support)	
	LED Activity	LED Off – Radio OFF; Solid LED On – Radio ON		
	 Maximum output po In Power Save Pollir Receiver sensitivity is packet error rate of WLAN supplier's clie 	ower may vary by country ng mode. s measured at a packet e 10% for 802.11a/g (OF	isco Compatible Extensions support. WLAN may also	
Intel PRO/Wireless 3945BG 802.11b/g	Wireless LAN Standards	IEEE 802.11b IEEE 802.11g		
Network Connection	Interoperability	Wi-Fi certified Cisco Compatible Extensions Program compliant (details at www.hp.com/go/notebooks/WLAN)		
	Frequency Band	2.4 GHz		
	Data Rates	802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps		
	Modulation	Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM		
	Security ¹		bit WEP, WPA, WPA2, hardware-accelerated AES, ypes EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP- -FAST, EAP-SIM.	
			rity Features (proven compatibility with Cisco Aironet through the Cisco Compatible Extensions Program	



Technical Specifications

Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.		
Media Access Protocol	CSMA/CA (Collision Avoidance) with ACK		
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point	t Required)	
Roaming	IEEE 802.11 compliant ro	aming between access points	
Output Power (for CKK) ²	15 dBm		
Output Power (for OFDM, power varies by data rate) ²	; 15 dBm		
Power Consumption	Transmit: 1.8 Watts (max) Receive: 1.4 Watts (max) Idle mode ³ : 150 mW (nor Sleep mode: 30 mW (max		
Power Management	ACPI compliant power ma 802.11 compliant power s	0	
Receiver Sensitivity ⁴	54 Mbps: -72 dBm, 11 M	bps: -88 dBm , 1 Mbps: -97 dBm	
Antenna type	High efficiency dual band display enclosure	antenna with spatial diversity, mounted in the	
Range	802.11 b – Typical (@1 Mbps)	1200 feet – Outdoor Open Area 300 feet – Indoor, Office environment	
	802.11 g – Typical (@1 Mbps)	1200 feet – Outdoor Open Area 300 feet – Indoor, Office environment	
Form Factor	PCI-Express MiniCard		
Weight	0.013 lb (6 g)		
Dimensions	0.19 x 1.2 x 2.0 in (4.75 x	< 29.85 x 50.8 mm)	
Operating Voltage	3.3v +/- 10%		
Temperature	Operating Non-operating	32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C)	
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)	
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)	
Configuration Utility ⁵	Choice of Configuration U	Itility:	
		XP Wireless Network Connection Manager ed for Cisco Compatible Extensions support)	
LED Activity	LED Off – Radio OFF; Soli	d LED On – Radio ON	
 Maximum output po In Power Save Pollin 	wer may vary by country ac g mode.	on supported security features. cording to local regulations.	
		r rate of 8% for 802.11b (CKK modulation) and a	
5. WLAN supplier's clie	10% for 802.11a/g (OFDM nt utility is required for Cisc certain third-party software s	o Compatible Extensions support. WLAN may also	

HP Integrated Module

Bluetooth Specification 2.0 Compliant



Technical Specificati	ions			
with Bluetooth Wireless	Dimensions	1.02 x 0.55 x 0.22 in (26 x 14 x 5.7 mm)		
Technology	Frequency Band	2402 to 2480 MHz		
	Number of Available Channels	79 (1 MHz) available	channels	
	Data Rates and	3 Mbps data rate; th	roughput up to 2.17 Mbps	
	Throughput	Synchronous Connec	tion Oriented links up to 3, 64 kbps, voice channels	
		Asynchronous Conne 1306.9 kbps symmet	ction Less links 2178.1 kbps/177.1 kbps asymmetric or ric	
	Transmit Power	-6 dBm to 4 dBm (Bluetooth Class II)		
	Receiver Sensitivity	Better than -80 dBM at 0.1 % raw bit error rate		
	Power Consumption	Peak (Tx) 264 mW		
		Peak (Rx) 231 mW		
		Sleep <1 mW		
	Antenna	Internally integrated within module		
	Range	Up 33 ft (10 m)		
	Electrical Interface	USB 2.0 compliant		
		Microsoft Windows Plug and Play compliant		
	OS Support	Microsoft Windows X	P Professional and Home	
		Microsoft Windows 2	000	
	Bluetooth Software	Broadcom Bluetooth	for Windows	
	Supported	Microsoft Windows XP Bluetooth Software		
	Link Topology	Point to Point, Multipoint Pico Nets up to 7 slaves		
	Security	Full support of Bluetooth Security Provisions		
	Power Management	Microsoft Windows A	CPI, and USB Bus Support	
		Self configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff		
	Certifications	All necessary regulatory approvals for supported countries, including:		
		FCC (47 CFR) Part 15C, Section 15.247 & 15.249		
		ETS 300 328, ETS 300 826		
		Low Voltage Directive IEC950		
		UL, CSA, and CE Ma	rk	
	Temperature	Operating	-4° to 158° F (-20° to 70° C)	
		Non-operating	-40° to 176° F (-40° to 80° C)	
	Humidity	Operating	10% to 90%	
		Non-operating	5% to 95%	
	Altitude	Operating	15,000 ft (4,572 m)	
			· · · · · · · · · · · · · · · · · · ·	



Non-operating

40,000 ft (12,192 m)

Technical Specifications	
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	Bluetooth Profiles	(with Bluetooth for Windows 4.0 software)		
Supported		Serial Port Profile (SPP)*		
		Dial-Up Networking (DU	N)*	
	Generic Object Exchange	e Profile (GOEP)		
		Object Push Profile (OPP)*	
		File Transfer Profile (FTP)		
		Synchronization Profile (S	YNC)	
		Hard Copy Cable Replac	ement (HCRP)*	
		Personal Area Networkin	g Profile (PAN)*	
		Human Interface Device	Profile (HID)*	
		FAX Profile (FAX)		
		Basic Imaging Profile (BIF	2)	
		Headset Profile (HSP)		
		Hands Free Profile (HFP)		
		Advanced Audio Distribu	tion Profile (A2DP)	
	* indicates the profile is als	so supported by Microsoft ^v	Windows XP SP2	
Environmental Data	Eco-Label Certifications	This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:		
		 US Energy Star US Federal Energy Taiwan Green Mar China Energy Con IT ECO declaration 	servation Program	EMP)
	System Configuration	The configuration used for the Energy Consumption and Declared Noise Emissions data is based on a "Typically Configured Notebook."		
	Energy Consumption	115 VAC	230 VAC	100 VAC
	Normal Operation	23.0 W	23.5 W	23.0 W
	Sleep (Energy Star low power mode)	1.72 W	1.88 W	1.73 W
	Off	1.90 W	1.90 W	1.98 W
	Heat Dissipation*	115 VAC	230 VAC	100 VAC
	Normal Operation	78 BTU/hr	80 BTU/hr	78 BTU/hr
	Sleep	5.9 BTU/hr	6.4 BTU/hr	5.9 BTU/hr
	Off	6.5 BTU/hr	6.8 BTU/hr	6.5 BTU/hr
		*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.		
		This product is in compli	ance with US executive or	ler 13221 WOL (wake

This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.



Technical Specifications

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Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (LWAd, bels)	Sound Pressure (LpAm, decibels)
Idle	3.2	23
Fixed Disk (random writes)	3.8	24
Batteries	This product complies with ISO standard	ds:
	EU Directive 91/ 157/ EEC EU Directive 93/ 86/ EEC EU Directive 98/ 101/ EEC	
	Batteries used in the product do not con	tain:
	Mercury greater than 5ppm by we Cadmium greater than 10ppm by Lead greater than 4000 ppm by	y weight
	Battery type and chemistry used in the p	roduct:
	Primary battery 6-cell high capacity Lithium-Ion b	pattery pack
Additional Information	Real Time Clock battery CR2032 (coin cell), Lithium This product is in compliance with the R (RoHS) directive – 2002/95/EC.	estrictions of Hazardous Substances
	This HP product is designed to comply v Electronic Equipment (WEEE) Directive -	
	Keyboard complies with ISO standard: ISO/IEC 15412	SO 9995, EN 29241-4, and
	Input devices of this product comply with	h ISO 9241, part 9.
	Plastics parts weighing over 0.055 pour are marked per ISO 11469 and ISO10	
	This product contains 0% recycled mate	rials (by wt.)
	This product is greater than 85% recycle end of life.	e-able when properly disposed of at



Technical Specifications			
	Packaging	Packaging Materials	
		 External: Corrugated Paper – 2.03 lb (920 g) Internal: Corrugated Paper – 1.84 lb (835 g) EPE Foam – 0.12 lb (55 g) LDPE Bag – 0.01 lb (5 g) The corrugated paper packaging materials contains at least 80% recycled content. 	
		HP follows these guidelines to decrease the environmental impact of product packaging:	
		 Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. Eliminate the use of ozone-depleting substances (ODS) in packaging materials. Design packaging materials for ease of disassembly. Maximize the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards. 	
	Material Usage	This product does not contain any of the following substances in excess of regulatory limits (for reference of these limits please refer to the HP General Specification of the Environment (<u>http://www.hp.com/hpinfo/globalcitizenship/environment/</u> <u>supplychain/gen_specifications.html</u>):	
		 Asbestos Certain Azo Colorants Certain Brominated Flame Retardants – may not be used as flame retardants in plastics Cadmium Chlorinated Hydrocarbons Chlorinated Paraffins Formaldehyde Halogenated Diphenyl Methanes Lead carbonates and sulfates Lead and Lead compounds Mercuric Oxide Batteries Nickel - finishes must not be used on the external surface designed to be frequently handled or carried by the user. Ozone Depleting Substances Polybrominated Biphenyl Ethers (PBBEs) Polybrominated Biphenyl Oxides (PBBOs) 	

- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain



10

Technical Specification	าร	
		retail packaging has been voluntarily removed from most applications. • Radioactive Substances • Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
	End-of-life Management and Recycling	HP offers our customers several other options for handling their aging computers while also minimizing the impact on the environment-including product trade-in and leasing services-in addition to recycling services. please go to: <u>http://www.hp.com/recycle</u> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.
-	Hewlett-Packard	For more information about HP's commitment to the environment:
(Corporate Environmental	
I	Information	Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Environment website http://www.hp.com/environment Eco-label certifications http://www.hp.com/hpinfo/globalcitizenship/environment/ productdesign/ecolabels.html ISO 14001 certificates: http://www.hp.com/hpinfo/globalcitizenship/environment/ operations/envmanagement.html

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